

Page 1 of 4

SERIES H130BA

FEATURES

- ISO/TS 16949 CERTIFIED FACILITY
- RELIABILITY TESTING PER AEC-Q200
- PPAP DOCUMENTATION AVAILABLE
- SMALL PACKAGE OF 5.0 x 3.2 mm
- EXCELLENT TOLERANCE AND STABILITY
- CUSTOM SPECIFICATIONS AVAILABLE



SPECIFICATIONS

PARAME	TER	VALUE			
FREQUENCY RANGE		8.000 MHz to 65.000 MHz			
MODE OF OSCILLATION FUNDAMENTAL		8.000 MHz to 65.000 MHz			
FREQUENCY TOLERANCE AT 25°C		±50 ppm max (±10 ppm, ±15 ppm, ±20 ppm and ±30 ppm available)			
FREQUENCY STABILITY OV	/ER TEMPERATURE ‡	±50 ppm max (±10 ppm, ±15 ppm, ±20 ppm and ±30 ppm available, see Table 2)			
OPERATING TEMPERATUR	E RANGE ‡	-20°C to +70°C Standard -40°C to +85°C Extended -40°C to +105°C Extended6 -40°C to +125°C Extended1			
STORAGE TEMPERATURE	RANGE	-55°C to +125°C			
AGING		±1 ppm per year max			
LOAD CAPACITANCE		6 pF to 32 pF or Series			
EQUIVALENT SERIES RESISTANCE		See Table 1			
SHUNT CAPACITANCE		5.0 pF max			
DRIVE LEVEL		100 μW typ, 500 μW max			
INSULATION RESISTANCE		500 MΩ min			
SHOCK RESISTANCE		±5 ppm max 75 cm drop test in 3 axes onto a hard wood surface			
REFLOW CONDITIONS		260°C for 10 s max			





‡ Not all combinations of temperature and frequency stability available, consult factory.

TABLE 1					
FREQUENCY (MHz)	MODE	ESR MAX (Ω)			
8≤F0<10	FUND	80			
10≤F0<12	FUND	65			
12≶F0<16	FUND	55			
16≤F0<20	FUND	50			
20≤F0<30	FUND	40			
30≶F0≤65	FUND	30			

TABLE 2						
TEMP RANGE	STABILITY (ppm)					
(°C)	±10	±15	±20	±30	±50	
-20 to +70	0	0	0	0	0	
-40 to +85	X 0 0 0 0					
-40 to +105	×	Δ	\triangle	0	0	
-40 to +125	×	×	×	Δ	0	
Note: O: Available, △: Conditional, ×: Not available						



Page 2 of 4

SERIES H130BA

PART NUMBERING SYSTEM

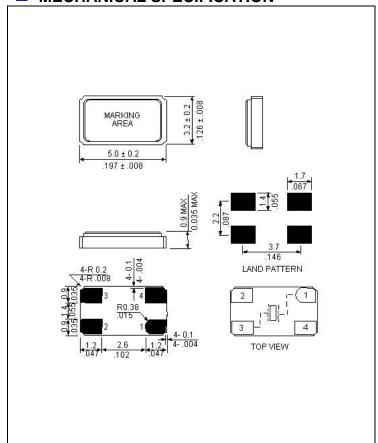
TYPE	•	FREQUENCY	•	LOAD CAPACITANCE	1	MODE	•	TOLERANCE/STABLITY (PPM/PPM)
H130BA	-	in MHz	1	8 to 32 pF for Parallel S for Series	1	Blank for < 24.576 MHz F for ≥ 24.576 MHz	•	Blank for max ppmppm Example: 1020, 2050

-	EXTENDED TEMPERATURE	ı	TAPE & REEL
-	Blank for Standard EXT for Extended EXT6 for Extended6 EXT1 for Extended1	-	TR

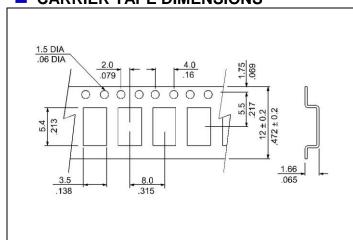
EXAMPLE: H130BA-24.000-18-3050-EXT1-TR

AUTOMOTIVE GRADE Surface Mount Microprocessor Crystal, H10SA package, 5.0 x 3.2 mm, 24.000 MHz, Fundamental mode, 18 pF Load, ±30 ppm Tolerance, ±50 ppm Stability from -40°C to +125°C, Tape and reel packaging

MECHANICAL SPECIFICATION



CARRIER TAPE DIMENSIONS



NOTE: REFER TO EIA-481 FOR NON-SPECIFIED DIMENSIONS

PACKAGING

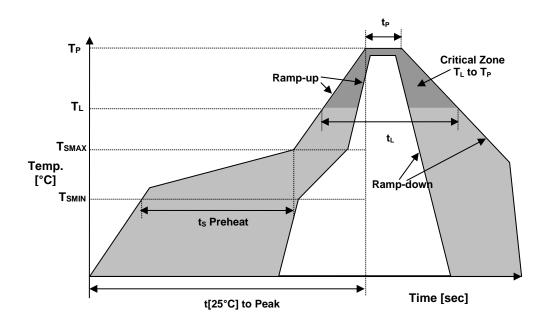
180 mm REEL DIAMETER 12 mm TAPE WIDTH, 8 mm PITCH QUANTITY: 1000 PIECES PER REEL



Page 3 of 4

SERIES H130BA

REFLOW PROFILE



Reflow profile (Reference IPC/JEDEC J-STD-020)					
Temperature Min Preheat	T _{SMIN}	150°C			
Temperature Max Preheat	T _{SMAX}	200°C			
Time (T _{SMIN} to T _{SMAX})	ts	60-180 sec.			
Temperature	T _L	217°C			
Peak Temperature	T _P	260°C			
Ramp-up rate	R_{UP}	3°C/sec max.			
Ramp-down rate	R _{DOWN}	6°C/sec max.			
Time within 5°C of Peak Temperature	t _P	10 sec.			
Time t[25°C] to Peak Temperature	t[25°C] to Peak	480 sec.			
Time	t _L	60-150 sec.			

ENVIRONMENTAL

PARAMETER	VALUE
MOISTURE SENSITIVITY LEVEL	1
RoHS	Compliant
REACH SVHC	Compliant
HALOGEN-FREE	Compliant
TERMINATION FINISH	Au
UNIT WEIGHT	0.0475 g





Page 4 of 4

SERIES H130BA

The process of manufacturing H130BA series of Automotive Grade Surface Mount Microprocessor Crystals is performed by using **Advanced Product Quality Planning** (APQP). This technique defines and establishes the following actions:

- Product design activities communicating special characteristics to the process design activity, prior to design release, linking the DFMEA to PFMEA.
- Plan, acquire and install appropriate process equipment and tooling based on design tolerances provided by the customer. – CPPD (Collaborative Product Process Design)
- Assembly personnel communicating suggestions on better ways to assemble a product prior to the completion
 of the design of the product. DFA/M (Design for Assembly and Manufacturing)
- Manufacturing or Process Engineering establishing adequate Quality Controls for features of a product or parameters of a process, which still risk potential failure. – Control Plan Methodology
- Performing Stability and Capability studies on special characteristics to understand the variation present and predict future performance. – SPC (Statistical Process Control and Process Capability)

Request for <u>Production Part Approval Process</u> (PPAP) documentation must be requested at time of order placement. Requests for part approval will be supported in official PPAP format and with documented results as requested at time of order placement. Actual measurements are taken of the parts produced and are used to complete the various test sheets of PPAP.

NOTICE

If you intend to use our product referenced above in an automotive application that may result in loss of life or assets, please do not fail to advise us of your intention beforehand. The use of the listed part in those applications is not covered by warranty, and we will not be held accountable for any liability claims. We reserve the right to not supply parts in those circumstances.

NOVEMBER 2016